Ordering number : ENN*6302

CMOS IC

LC35256FM, FT-55U/70U

256K (32768 words × 8 bits) SRAM
Control Pins: $\overline{OE}$ and $\overline{CE}$

Preliminary

Overview

The LC35256FM and LC35256FT are asynchronous silicon-gate CMOS SRAMs with a 32K-word by 8-bit structure. These are full-CMOS devices with 6 transistors per memory cell, and feature low-voltage operation, a low operating current drain, and an ultralow standby current. Control inputs include $\overline{OE}$ for fast memory access and $\overline{CE}$ (chip enable) for power saving and device selection. This makes these devices optimal for systems that require low power or battery backup, and makes memory expansion easy. The ultralow standby current allows these devices to be used with capacitor backup as well.

Features

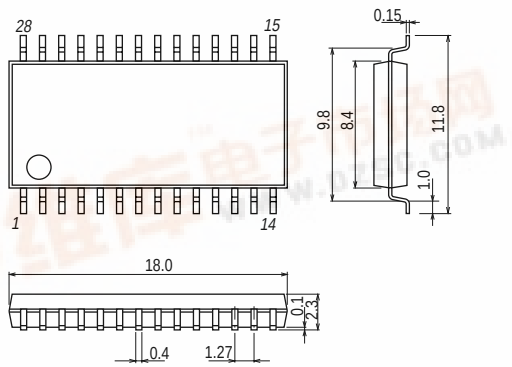
- Supply voltage range: 4.5 to 5.5 V
- Access time at 5 V operation:
  LC35256FM, FT-55U: 55 ns (maximum)
  LC35256FM, FT-70U: 70 ns (maximum)
- Standby current: 3.0 µA (Ta ≤ 70°C)
  5.0 µA (Ta ≤ 85°C)
- Operating temperature: –40 to +85°C
- Data retention voltage: 2.0 to 5.5 V
- All I/O levels: TTL compatible
- Input/output shared function pins, 3-state output pins
- No clock required
- Package
  28-pin SOP (450 mil) plastic package: LC35256FM
  28-pin TSOP (8 × 13.4 mm) plastic package: LC35256FT

Package Dimensions

unit: mm

3187A-SOP28D

[LC35256FM]

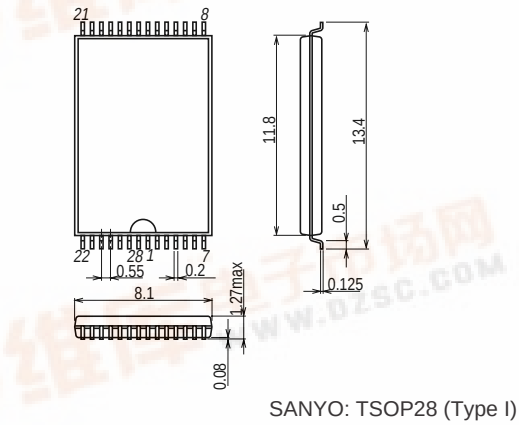


SANYO: SOP28D

unit: mm

3221-TSOP28 (Type I)

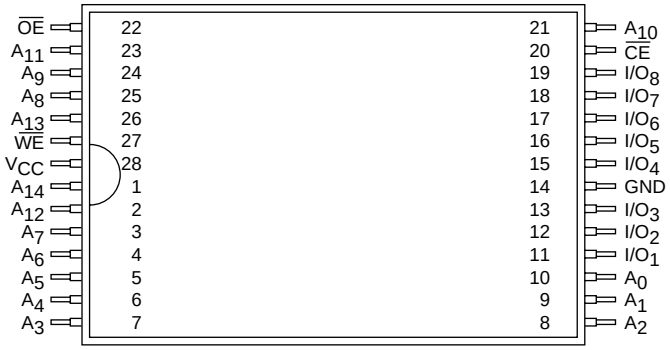
[LC35256FT]



SANYO: TSOP28 (Type I)

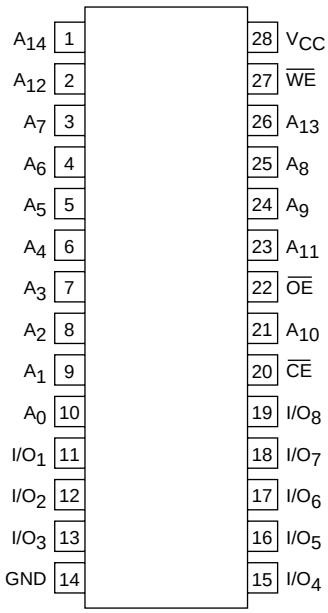
Pin Assignment (Top view)

TSOP28



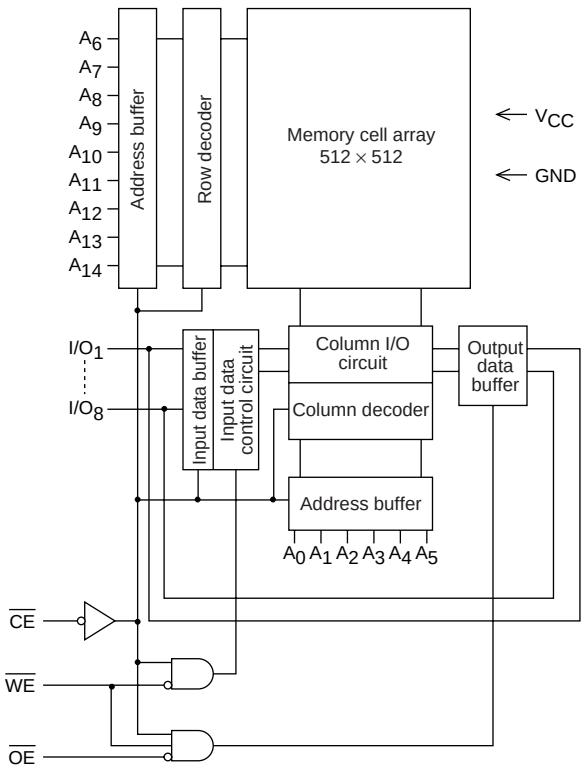
LC35256FT

SOP28D



LC35256FM

Block Diagram



Pin Functions

A0 to A14	Address input
$\overline{WE}$	Read/write control input
$\overline{OE}$	Output enable input
$\overline{CE}$	Chip enable input
I/O1 to I/O8	Data I/O
V_{CC}, GND	Power supply, ground

Function Table

Mode	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	I/O	Supply current
Read cycle	L	L	H	Data output	I_{CCA}
Write cycle	L	X	L	Data input	I_{CCA}
Output disable	L	H	H	High impedance	I_{CCA}
Unselected	H	X	X	High impedance	I_{CCS}

Specifications

Absolute Maximum Ratings

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V_{CC} max		7.0	V
Input pin voltage	V_{IN}		–0.3* to V_{CC} + 0.3	V
I/O pin voltage	$V_{I/O}$		–0.3 to V_{CC} + 0.3	V
Operating temperature	Topr		–40 to +85	°C
Storage temperature	Tstg		–55 to +125	°C

Note: * The minimum value is –3.0 V for pulse widths under 30 ns.

I/O Capacitances at Ta = 25°C, f = 1 MHz

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
I/O pin capacitance	$C_{I/O}$	$V_{I/O}$ = 0 V		6	10	pF
Input pin capacitance	C_I	V_{IN} = 0 V		6	10	pF

Note: All units are not tested; only samples are tested.

DC Allowable Operating Ranges at Ta = –40 to +85°C, V_{CC} = 4.5 to 5.5 V

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Supply voltage	V_{CC}		4.5	5.0	5.5	V
Input voltage	V_{IH}		2.2		V_{CC} + 0.3	V
	V_{IL}		–0.3*		+0.8	V

Note: * The minimum value is –3.0 V for pulse widths under 30 ns.

DC Electrical Characteristics at Ta = –40 to +85°C, V_{CC} = 4.5 to 5.5 V

Parameter		Symbol	Conditions			Ratings min	Ratings typ*	Ratings max	Unit
Input leakage current		I_{LI}	V_{IN} = 0 to V_{CC}			–1.0		+1.0	µA
Output leakage current		I_{LO}	$V_{\overline{CE}} = V_{IH}$ or $V_{\overline{OE}} = V_{IH}$ or $V_{\overline{WE}} = V_{IL}$, $V_{I/O}$ = 0 to V_{CC}			–1.0		+1.0	µA
Output high-level voltage		V_{OH}	I_{OH} = –1.0 mA			2.4			V
Output low-level voltage		V_{OL}	I_{OL} = 2.0 mA					0.4	V
Operating current drain	TTL inputs	I_{CCA2}	$V_{\overline{CE}} = V_{IL}$, $I_{I/O}$ = 0 mA, $V_{IN} = V_{IH}$ or V_{IL}					5.0	mA
		I_{CCA3}	$V_{\overline{CE}} = V_{IL}$, $V_{IN} = V_{IH}$ or V_{IL}, $I_{I/O}$ = 0 mA, Duty 100 %	Min. cycle	LC35256FM, FT-55U		40	45	mA
					LC35256FM, FT-70U		35	40	
				1 µs cycle			3.5	6.0	
Standby mode current drain	V_{CC} – 0.2 V/ 0.2 V inputs	I_{CCS1}	$V_{\overline{CE}} \geq V_{CC}$ – 0.2 V, V_{IN} = 0 to V_{CC}	Ta ≤ 25°C			0.05		µA
				Ta ≤ 60°C				1.5	
				Ta ≤ 70°C				3.0	
				Ta ≤ 85°C				5.0	
	TTL inputs	I_{CCS2}	$V_{\overline{CE}} = V_{IH}$, V_{IN} = 0 to V_{CC}					1.0	mA

Note: * Reference values when V_{CC} = 5 V and Ta = 25°C.

AC Electrical Characteristics at Ta = –40 to +85°C, V_{CC} = 4.5 to 5.5 V

AC test conditions
Input pulse voltage levels: V_{IH} = 2.4 V, V_{IL} = 0.6 V
Input rise and fall times: 5 ns
Input and output timing levels: 1.5 V
Output load: 30 pF + 1 TTL gate (including the jig capacitance)

Read Cycle

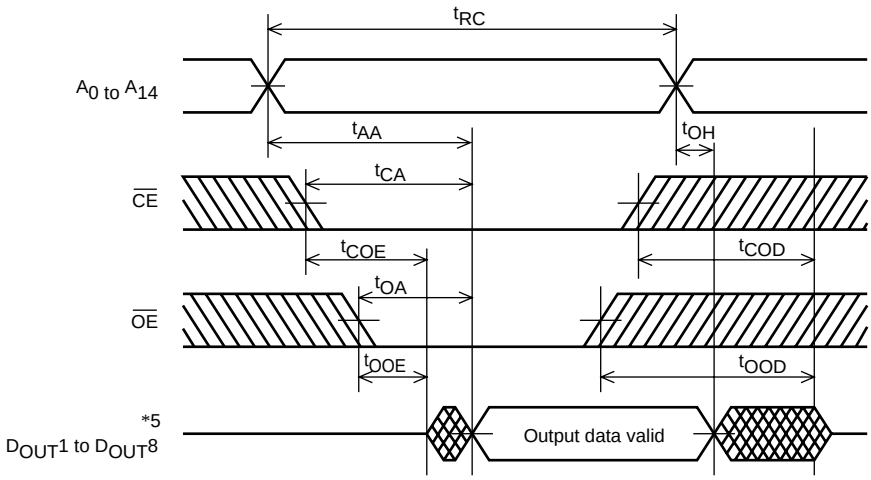
Parameter	Symbol	LC35256FM, FT -55U min	LC35256FM, FT -55U max	LC35256FM, FT -70U min	LC35256FM, FT -70U max	Unit
Read cycle time	t_{RC}	55		70		ns
Address access time	t_{AA}		55		70	ns
$\overline{CE}$ access time	t_{CA}		55		70	ns
$\overline{OE}$ access time	t_{OA}		30		35	ns
Output hold time	t_{OH}	10		10		ns
$\overline{CE}$ output enable time	t_{COE}	5		10		ns
$\overline{OE}$ output enable time	t_{OOE}	5		5		ns
$\overline{CE}$ output disable time	t_{COD}		20		30	ns
$\overline{OE}$ output disable time	t_{OOD}		20		25	ns

Write Cycle

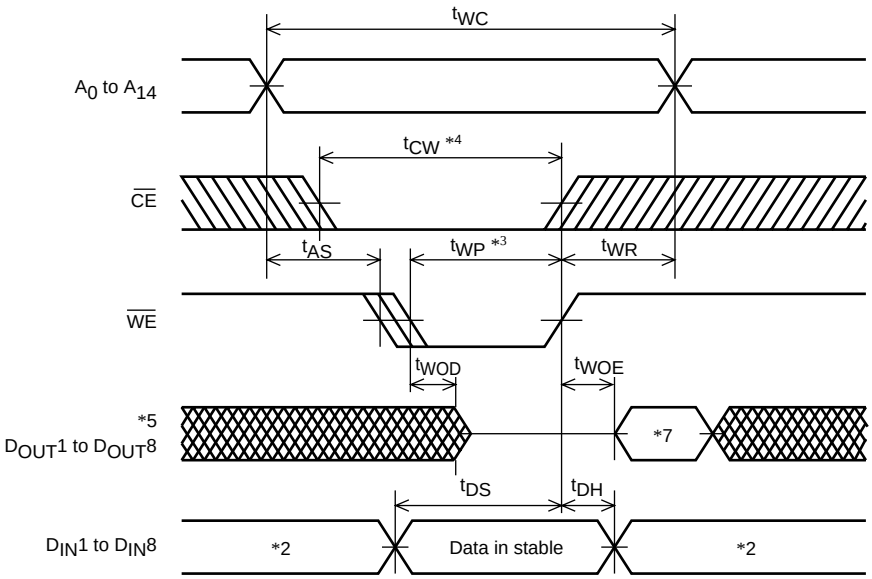
Parameter	Symbol	LC35256FM, FT -55U min	LC35256FM, FT -55U max	LC35256FM, FT -70U min	LC35256FM, FT -70U max	Unit
Write cycle time	t_{WC}	55		70		ns
Address setup time	t_{AS}	0		0		ns
Write pulse width	t_{WP}	40		50		ns
$\overline{CE}$ setup time	t_{CW}	50		60		ns
Write recovery time	t_{WR}	0		0		ns
$\overline{CE}$ write recovery time	t_{WR1}	0		0		ns
Data setup time	t_{DS}	25		30		ns
Data hold time	t_{DH}	0		0		ns
$\overline{CE}$ data hold time	t_{DH1}	0		0		ns
$\overline{WE}$ output enable time	t_{WOE}	5		5		ns
$\overline{WE}$ output disable time	t_{WOD}		20		30	ns

Timing Charts

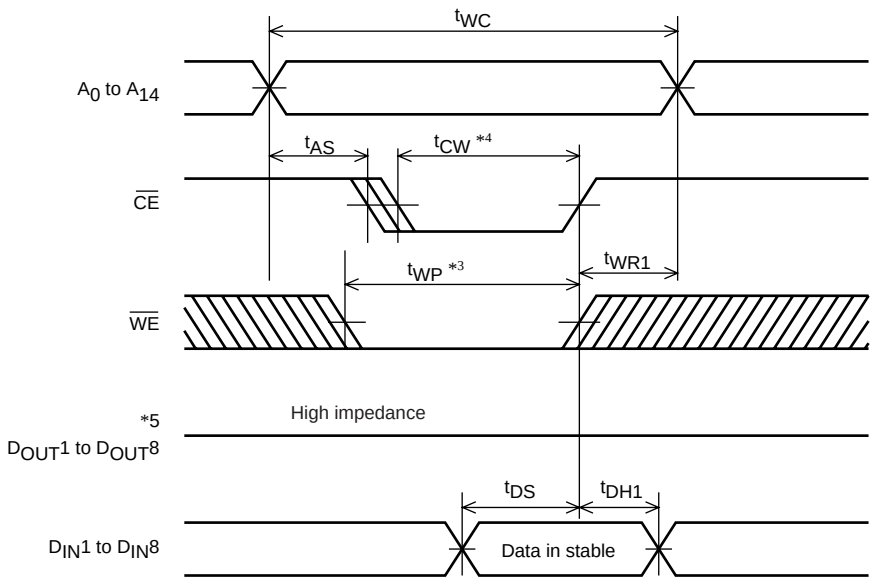
[Read cycle] *1



[Write cycle 1] ($\overline{WE}$ write) *6



[Write cycle 2] ($\overline{CE}$ write) *6



Notes: 1. $\overline{WE}$ must be held at the high level during the read cycle.
2. Do not apply reverse phase signals to the D_{OUT} pins when those pins are in the output state.
3. The time t_{WP} is the period when both $\overline{CE}$ and $\overline{WE}$ are low. It is defined as the time from the fall of $\overline{WE}$ to the rise of $\overline{CE}$ or $\overline{WE}$, whichever occurs first.
4. The time t_{CW} is the period when both $\overline{CE}$ and $\overline{WE}$ are low. It is defined as the time from the fall of $\overline{CE}$ to the rise of $\overline{CE}$ or $\overline{WE}$, whichever occurs first.
5. The D_{OUT} pins will be in the high-impedance state if any one of the following hold: $\overline{OE}$ is at the high level, $\overline{CE}$ is at the high level, or $\overline{WE}$ is at the low level.
6. The $\overline{OE}$ pin must be either held high or held low during the write cycle.
7. D_{OUT} has the same phase as the write data during this write cycle.

Circuit Design Notes

When designing application circuits, always take the following into consideration and design the circuits so that the absolute maximum ratings are never exceeded.

- Supply voltage fluctuations
- Sample-to-sample variations in the electrical characteristics of the electronic components used, including semiconductor devices, resistors, and capacitors.
- Ambient temperature
- Variations in the input and clock signals
- The application of abnormal pulses

Furthermore, be sure to operate this device within the stipulated ranges of all parameters for which an allowable operating range is specified.

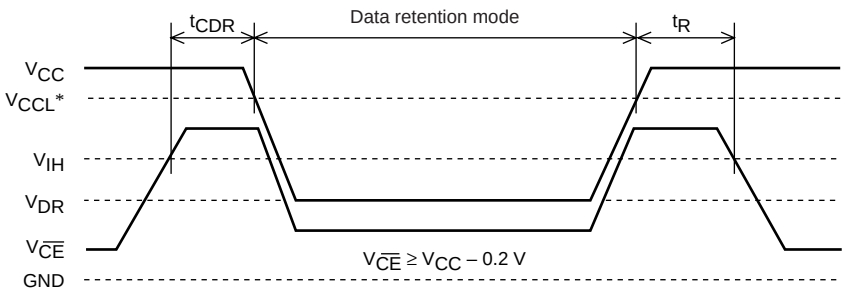
When CMOS IC input pins are left in the open state, through currents may occur in internal circuits to which intermediate voltage levels are applied, and this can result in incorrect circuit operation. Be sure to handle all unused input pins as specified in the device documentation.

Data Retention Conditions at Ta = –40 to +85°C

Parameter	Symbol	Conditions		min	typ*	max	Unit
Data retention supply voltage	V_{DR}	$V_{\overline{CE}} \geq V_{CC} - 0.2$ V		2.0		5.5	V
Data retention supply current	I_{CCDR}	V_{CC} = 3.0 V $V_{\overline{CE}} \geq V_{CC} - 0.2$ V	Ta ≤ 25°C		0.02		µA
			Ta ≤ 60°C			1.0	
			Ta ≤ 70°C			2.0	
			Ta ≤ 85°C			3.5	
Chip enable setup time	t_{CDR}			0			ns
Chip enable hold time	t_R			t_{RC}**			ns

Note: * Reference values for V_{CC} = 3 V, Ta = 25°C.
** t_{RC}: Read cycle time

Data Retention Waveforms



Note: * V_{CCL} 5 V operation: 4.5 V